

Errata

MSP430F2618 Microcontroller



ABSTRACT

This document describes the known exceptions to the functional specifications (advisories).

Table of Contents

| | |
|---|----|
| 1 Functional Advisories | 2 |
| 2 Preprogrammed Software Advisories | 2 |
| 3 Debug Only Advisories | 3 |
| 4 Fixed by Compiler Advisories | 3 |
| 5 Nomenclature, Package Symbolization, and Revision Identification | 4 |
| 5.1 Device Nomenclature..... | 4 |
| 5.2 Package Markings..... | 4 |
| 5.3 Memory-Mapped Hardware Revision (TLV Structure)..... | 5 |
| 6 Advisory Descriptions | 6 |
| 7 Revision History | 23 |

1 Functional Advisories

Advisories that affect the device's operation, function, or parametrics.

✓ The check mark indicates that the issue is present in the specified revision.

| Errata Number | Rev H | Rev F | Rev E |
|-------------------------|-------|-------|-------|
| ADC25 | ✓ | ✓ | ✓ |
| BCL12 | ✓ | ✓ | ✓ |
| BCL13 | | | ✓ |
| BCL15 | ✓ | ✓ | ✓ |
| DAC4 | ✓ | ✓ | ✓ |
| DMA3 | ✓ | ✓ | ✓ |
| DMA4 | ✓ | ✓ | ✓ |
| DMA13 | ✓ | ✓ | ✓ |
| FLASH19 | ✓ | ✓ | ✓ |
| FLASH24 | ✓ | ✓ | ✓ |
| FLASH25 | | | ✓ |
| FLASH27 | ✓ | ✓ | ✓ |
| FLASH36 | ✓ | ✓ | ✓ |
| PORT10 | ✓ | ✓ | ✓ |
| PORT12 | ✓ | ✓ | ✓ |
| TA12 | ✓ | ✓ | ✓ |
| TA16 | ✓ | ✓ | ✓ |
| TA21 | ✓ | ✓ | ✓ |
| TAB22 | ✓ | ✓ | ✓ |
| TB2 | ✓ | ✓ | ✓ |
| TB16 | ✓ | ✓ | ✓ |
| TB24 | ✓ | ✓ | ✓ |
| USCI20 | ✓ | ✓ | ✓ |
| USCI21 | ✓ | ✓ | ✓ |
| USCI22 | ✓ | ✓ | ✓ |
| USCI23 | ✓ | ✓ | ✓ |
| USCI24 | ✓ | ✓ | ✓ |
| USCI25 | ✓ | ✓ | ✓ |
| USCI26 | ✓ | ✓ | ✓ |
| USCI27 | ✓ | ✓ | ✓ |
| USCI30 | ✓ | ✓ | ✓ |
| USCI34 | ✓ | ✓ | ✓ |
| USCI35 | ✓ | ✓ | ✓ |
| USCI40 | ✓ | ✓ | ✓ |
| XOSC5 | ✓ | ✓ | ✓ |
| XOSC8 | | ✓ | ✓ |

2 Preprogrammed Software Advisories

Advisories that affect factory-programmed software.

✓ The check mark indicates that the issue is present in the specified revision.

The device does not have any errata for this category.

3 Debug Only Advisories

Advisories that affect only debug operation.

✓ The check mark indicates that the issue is present in the specified revision.

| Errata Number | Rev H | Rev F | Rev E |
|------------------------|-------|-------|-------|
| JTAG23 | ✓ | ✓ | ✓ |

4 Fixed by Compiler Advisories

Advisories that are resolved by compiler workaround. Refer to each advisory for the IDE and compiler versions with a workaround.

✓ The check mark indicates that the issue is present in the specified revision.

| Errata Number | Rev H | Rev F | Rev E |
|-----------------------|-------|-------|-------|
| CPU8 | ✓ | ✓ | ✓ |
| CPU16 | ✓ | ✓ | ✓ |
| CPU19 | ✓ | ✓ | ✓ |

Refer to the following MSP430 compiler documentation for more details about the CPU bugs workarounds.

TI MSP430 Compiler Tools (Code Composer Studio IDE)

- [MSP430 Optimizing C/C++ Compiler](#): Check the --silicon_errata option
- [MSP430 Assembly Language Tools](#)

MSP430 GNU Compiler (MSP430-GCC)

- [MSP430 GCC Options](#): Check -msilicon-errata= and -msilicon-errata-warn= options
- [MSP430 GCC User's Guide](#)

IAR Embedded Workbench

- [IAR workarounds for msp430 hardware issues](#)

5 Nomenclature, Package Symbolization, and Revision Identification

The revision of the device can be identified by the revision letter on the [Package Markings](#) or by the [HW_ID](#) located inside the TLV structure of the device.

5.1 Device Nomenclature

To designate the stages in the product development cycle, TI assigns prefixes to the part numbers of all MSP MCU devices. Each MSP MCU commercial family member has one of two prefixes: MSP or XMS. These prefixes represent evolutionary stages of product development from engineering prototypes (XMS) through fully qualified production devices (MSP).

XMS – Experimental device that is not necessarily representative of the final device's electrical specifications

MSP – Fully qualified production device

Support tool naming prefixes:

X: Development-support product that has not yet completed Texas Instruments internal qualification testing.

null: Fully-qualified development-support product.

XMS devices and X development-support tools are shipped against the following disclaimer:

"Developmental product is intended for internal evaluation purposes."

MSP devices have been characterized fully, and the quality and reliability of the device have been demonstrated fully. TI's standard warranty applies.

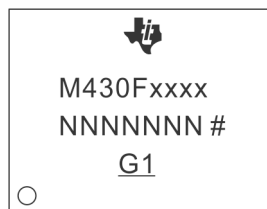
Predictions show that prototype devices (XMS) have a greater failure rate than the standard production devices. TI recommends that these devices not be used in any production system because their expected end-use failure rate still is undefined. Only qualified production devices are to be used.

TI device nomenclature also includes a suffix with the device family name. This suffix indicates the temperature range, package type, and distribution format.

5.2 Package Markings

ZQW113

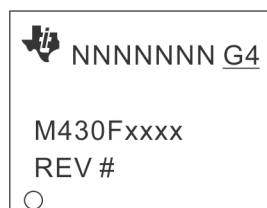
BGA (ZQW), 113 Pin



= Die revision
○ = Pin 1 location
N = Lot trace code

PM64

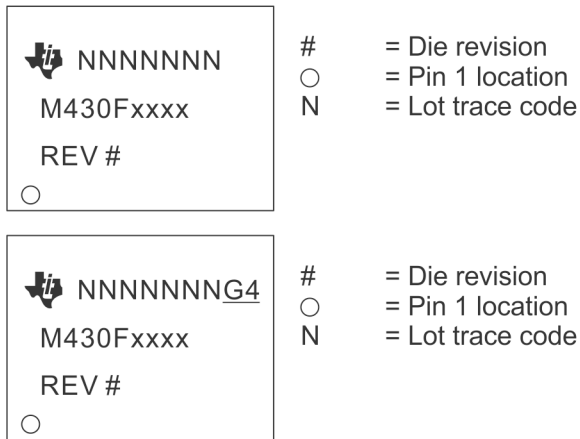
LQFP (PM), 64 Pin



= Die revision
○ = Pin 1 location
N = Lot trace code

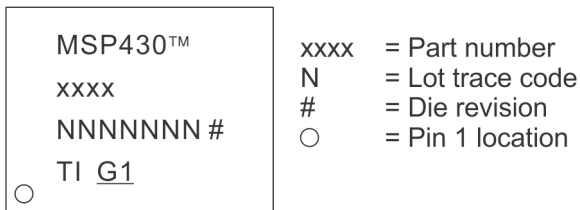
PN80

LQFP (PN), 80 Pin



ZCA113

NFBGA (ZCA), 113 Pin



5.3 Memory-Mapped Hardware Revision (TLV Structure)

This device does not support reading the hardware revision from memory.

Further guidance on how to locate the TLV structure and read out the HW_ID can be found in the device User's Guide.

6 Advisory Descriptions

ADC25 *ADC Module*

Category Functional

Function Write to ADC12CTL0 triggers ADC12 when CONSEQ = 00

Description If ADC conversions are triggered by the Timer_B module and the ADC12 is in single-channel single-conversion mode (CONSEQ = 00), ADC sampling is enabled by write access to any bit(s) in the ADC12CTL0 register. This is contrary to the expected behavior that only the ADC12 enable conversion bit (ADC12ENC) triggers a new ADC12 sample.

Workaround When operating the ADC12 in CONSEQ=00 and a Timer_B output is selected as the sample and hold source, temporarily clear the ADC12ENC bit before writing to other bits in the ADC12CTL0 register. The following capture trigger can then be re-enabled by setting ADC12ENC = 1.

BCL12 *BCL Module*

Category Functional

Function Switching RSELx or modifying DCOCTL can cause DCO dead time or a complete DCO stop

Description After switching RSELx bits (located in register BCSTL1) from a value of >13 to a value of <12 OR from a value of <12 to a value of >13, the resulting clock delivered by the DCO can stop before the new clock frequency is applied. This dead time is approximately 20 us. In some instances, the DCO may completely stop, requiring a power cycle.

Furthermore, if all of the RSELx bits in the BSCTL1 register are set, modifying the DCOCTL register to change the DCOx or the MODx bits could also result in DCO dead time or DCO hang up.

Workaround - When switching RSEL from >13 to <12, use an intermediate frequency step. The intermediate RSEL value should be 13.

| Current RSEL | Target RSEL | Recommended Transition Sequence |
|--------------|-------------|---|
| 15 | 14 | Switch directly to target RSEL |
| 14 or 15 | 13 | Switch directly to target RSEL |
| 14 or 15 | 0 to 12 | Switch to 13 first, and then to target RSEL (two step sequence) |
| 0 to 13 | 0 to 12 | Switch directly to target RSEL |

AND

- When switching RSEL from <12 to >13 it's recommended to set RSEL to its default value first (RSEL = 7) before switching to the desired target frequency.

AND

- In case RSEL is at 15 (highest setting) it's recommended to set RSEL to its default value first (RSEL = 7) before accessing DCOCTL to modify the DCOx and MODx bits. After the DCOCTL register modification the RSEL bits can be manipulated in an additional step.

In the majority of cases switching directly to intermediate RSEL steps as described above will prevent the occurrence of BCL12. However, a more reliable method can be implemented by changing the RSEL bits step by step in order to guarantee safe function without any dead time of the DCO.

Note that the 3-step clock startup sequence consisting of clearing DCOCTL, loading the BCSCTL1 target value, and finally loading the DCOCTL target value as suggested in the "TLV Structure" chapter of the [MSP430x2xx Family User's Guide](#) is not affected by BCL12 if (and only if) it is executed after a device reset (PUC) prior to any other modifications being made to BCSCTL1 since in this case RSEL still is at its default value of 7. However any further changes to the DCOx and MODx bits will require the consideration of the workaround outlined above.

BCL13

BCL Module

Category

Functional

Function

DCO powerup halt

Description

When subject to very slow Vcc rise times, the device may enter into a state where the DCO does not oscillate. No JTAG access or program execution is possible and the device will remain in a reset state until the supply voltage is disconnected.

Workaround

Apply a Vcc poweron ramp $\geq 10V/\text{second}$ under all power-on/power-cycle scenarios.

BCL15

BCL Module

Category

Functional

Function

Unpredictable device behavior if XT2 is sourcing SMCLK or MCLK while operating in LPM3

Description

If the MCLK or SMCLK is sourced by the XT2 oscillator, when the device wakes up from LPM3 or the SMCLK is requested by the USCI module an unpredictable glitch might appear. The glitch might appear on the corresponding clock signal with the 1st rising edge of the ACLK after wake-up. This can lead to a frequency violation.
In case of MCLK it can cause the device to hang up or execute code incorrectly.
In case of SMCLK any corresponding module using the clock can behave unpredictably.

Workaround

Do not use XT2 clock for MCLK/SMCLK when using LPM3

CPU8

CPU Module

Category

Compiler-Fixed

Function

Using odd values in the SP register

Description

If the stack pointer (SP) is written with an odd value then the first time that the SP is used, the LSB of the SP is forced to zero.

Workaround

Do not use odd values with the SP.

Refer to the table below for compiler-specific fix implementation information.

| IDE/Compiler | Version Number | Notes |
|---|----------------|-------|
| IAR Embedded Workbench | Not affected | |
| TI MSP430 Compiler Tools (Code Composer Studio) | Not affected | |

| IDE/Compiler | Version Number | Notes |
|----------------------------------|-----------------------------------|--|
| MSP430 GNU Compiler (MSP430-GCC) | MSP430-GCC 4.9 build 389 or later | User is required to add the compiler flag option below. -msilicon-errata=cpu8 -msilicon-errata-warn=cpu8 generates a warning in addition |
| MSP430 GNU Compiler (MSP430-GCC) | MSP430-GCC 5.x build 14 or later | User is required to add the compiler flag option below. -msilicon-errata=cpu8 -msilicon-errata-warn=cpu8 generates a warning in addition |

CPU16**CPU Module****Category**

Compiler-Fixed

Function

Indexed addressing with instructions calla, mova and bra.

Description

With indexed addressing mode and instructions calla, mova, and bra, it is not possible to reach memory above 64k if the register content is < 64k.

Example: Assume R5 = FFFEh. The instruction calla 0004h(R5) will result in a 20-bit call of address 0002h instead of 10002h.

Workaround

- Use different addressing mode to reach memory above 64k.
- First use adda [index],[Rx] to calculate address in upper memory and then do a calla [Rx]

Refer to the table below for compiler-specific fix implementation information.

| IDE/Compiler | Version Number | Notes |
|---|----------------------------|-------|
| IAR Embedded Workbench | IAR EW430 v6.30.1 or later | |
| TI MSP430 Compiler Tools (Code Composer Studio) | Fix not available | |
| MSP430 GNU Compiler (MSP430-GCC) | Fix not available | |

CPU19**CPU Module****Category**

Compiler-Fixed

Function

CPUOFF modification may result in unintentional register read

Description

If an instruction that modifies the CPUOFF bit in the Status Register is followed by an instruction with an indirect addressed operand (e.g. MOV @R8, R9, RET, POP, POPM), an unintentional register read operation can occur during the wakeup of the CPU. If the unintentional read occurs to a read sensitive register (e.g. UCB0RXBUF, TAIV), which changes its value or the value of other registers (IFG's), the bug leads to lost interrupts or wrong register read values.

Workaround

Insert a NOP instruction after each CPUOFF instruction.

OR

Refer to the table below for compiler-specific fix implementation information.
Note that compilers implementing the fix may lead to double stack usage when RET/
RETA follows the compiler-inserted NOP.

| IDE/Compiler | Version Number | Notes |
|---|-----------------------------------|---|
| IAR Embedded Workbench | IAR EW430 v6.20.1 until v6.40 | User is required to add the compiler or assembler flag option below. --hw_workaround=nop_after_lpm |
| IAR Embedded Workbench | IAR EW430 v6.40 or later | Workaround is automatically enabled |
| TI MSP430 Compiler Tools (Code Composer Studio) | 15.12.0.LTS | User is required to add the compiler or assembler flag option below. --silicon_errata=CPU19 |
| MSP430 GNU Compiler (MSP430-GCC) | MSP430-GCC 4.9 build 389 or later | User is required to add the compiler or assembler flag option below. -msilicon-errata=cpu19 -msilicon-errata-warn=cpu19 generates a warning in addition |
| MSP430 GNU Compiler (MSP430-GCC) | MSP430-GCC 5.x build 14 or later | User is required to add the compiler or assembler flag option below. -msilicon-errata=cpu19 -msilicon-errata-warn=cpu19 generates a warning in addition |

DAC4

DAC Module

Category

Functional

Function

DAC1 overwrites an input of the SVS comparator

Description

DAC1, when enabled (DAC12_1CTL.DAC12AMPx >0), overrides the input of the SVS comparator if SVSCTL.VLDx = 1111 (comparing external input voltage SVSIN to 1.25 V.) This is caused by a conflict between SVS and DAC1 at Port 6.7. This behavior only affects DAC output pins shared with SVSIN function.

Workaround

1) Do not enable DAC1 when SVS is used with VLDx = 1111

OR

2) Use DAC output pin not shared with SVSIN function

DMA3

DMA Module

Category

Functional

Function

Read-modify-write instructions may corrupt DMA address registers

Description

When a 16-bit wide read-modify-write instruction (such as add.w and sub.w) is directly used on a DMA address register (DMAxSA or DMAxDA), the register contents will get corrupted.

Workaround

1. Do not use 16-bit wide read-modify-write instructions on DMA address registers. Instead, in case address calculations are necessary, do the calculations first, and then assign the result to the DMA address registers.

- OR
2. Use 20-bit wide read-modify-write instructions (such as addx.a, subx.a) on the DMA address registers if needed.

DMA4***DMA Module*****Category**

Functional

Function

Corrupted write access to 20-bit DMA registers

Description

When a 20-bit wide write to a DMA address register (DMAxSA or DMAxDA) is interrupted by a DMA transfer, the register contents may be unpredictable.

Workaround

1. Design the application to guarantee that no DMA access interrupts 20-bit wide accesses to the DMA address registers.

OR

2. When accessing the DMA address registers, enable the Read Modify Write disable bit (DMARMWDIS = 1) or temporarily disable all active DMA channels (DMAEN = 0).

OR

3. Use word access for accessing the DMA address registers. Note that this limits the values that can be written to the address registers to 16-bit values (lower 64K of Flash).

DMA13***DMA Module*****Category**

Functional

Function

Clearing the DMAONFETCH bit may result in unpredictable code execution

Description

If the DMA module is used with DMACTL1.DMAONFETCH = 0, DMA transfer requests occur immediately upon receiving the request. This may result in unpredictable code execution by the CPU.

Workaround

Always ensure that DMACTL1.DMAONFETCH = 1. Note that this needs to be set explicitly by the user and is not the default setting for the DMACTL1 register.

FLASH19***FLASH Module*****Category**

Functional

Function

EEI feature does not work for code execution from RAM

Description

When the program is executed from RAM, the flash controller EEI feature does not work. The erase cycle is suspended and the interrupt is serviced, but there is a problem while resuming with the erase cycle.

Addresses applied to flash are different than the actual values while resuming erase cycle after ISR execution.

Workaround

None

FLASH24***FLASH Module*****Category**

Functional

| | |
|--------------------|--|
| Function | Write or erase emergency exit can cause failures |
| Description | <p>When a flash write or erase is abruptly terminated, the following flash accesses by the CPU may be unreliable resulting in erroneous code execution. The abrupt termination can be the result of one the following events:</p> <p>1) The flash controller clock is configured to be sourced by an external crystal. An oscillator fault occurs thus stopping this clock abruptly.</p> <p>or</p> <p>2) The Emergency Exit bit (EMEX in FCTL3) when set forces a write or an erase operation to be terminated before normal completion.</p> <p>or</p> <p>3) The Enable Emergency Interrupt Exit bit (EEIEX in FCTL1) when set with GIE=1 can lead to an interrupt causing an emergency exit during a Flash operation.</p> |
| Workaround | <p>1) Use the internal DCO as the flash controller clock provided from MCLK or SMCLK.</p> <p>or</p> <p>2) After setting EMEX = 1, wait for a sufficient amount of time before Flash is accessed again.</p> <p>or</p> <p>3) No Workaround. Do not use EEIEX bit.</p> |

FLASH25 *FLASH Module*

| | |
|--------------------|--|
| Category | Functional |
| Function | Marginal Read Mode is not functional |
| Description | The control bits for marginal read mode contained in the FCTL4 register are automatically cleared by any flash access. This prevents the marginal read mode from being used. |
| Workaround | <p>It is possible to read out memory contents in marginal read mode if the indexed addressing mode X(Ry) is used to access the flash memory. In this case, the FCTL4 control bits are not cleared, and the marginal read mode works as expected. It is recommended to write the code for reading the flash memory contents in assembler as this allows full control over the used addressing mode. Note that certain assemblers may optimize an indexed addressing source operation of 0(Ry) to an indirect register mode @Ry operation, which will not work. The following is an example of reading the word memory location 0x4000 in marginal read mode, preventing a possible assembler optimization:</p> <pre> mov.w #0x4000,R15 ; Pointer to target address dec.w R15 ; Decrement pointer mov.w 1(R15),R12 ; Read memory contents at R15+1, store result in R12 </pre> |

FLASH27 *FLASH Module*

| | |
|--------------------|--|
| Category | Functional |
| Function | EEl feature can disrupt segment erase |
| Description | <p>When a flash segment erase operation is active with EEl feature selected (EEI=1 in FLCTL1) and GIE=0, the following can occur:</p> <p>An interrupt event causes the flash erase to be stopped, and the flash controller expects an RETI to resume the erase. Because GIE=0, interrupts are not serviced and RETI will never happen.</p> |

Workaround 1) Do not set bit EEI=1 when GIE = 0.
or,
2) Force an RETI instruction during the erase operation during the check for BUSY=1 (FCLTL3).

Sample code:

```
MOV R5, 0(R5) ; Dummy write, erase segment
LOOP: BIT #BUSY, &FCTL3 ; test busy bit
JMP SUB_RETI ; Force RETI instruction
JNZ LOOP ; loop while BUSY=1
```

```
SUB_RETI: PUSH SR
RETI
```

FLASH36

FLASH Module

Category

Functional

Function

Flash content may degrade due to aborted page erases

Description

If a page erase is aborted by EEIEX, the flash page containing the last instruction before erase operation will start to degrade. This effect is incremental and, after repetitions, may lead to corrupted flash content.

Workaround

- Use the EEI (interrupted erasing) feature instead of EEIEX (abort erasing).
or
- A PSA checksum can be calculated over affected flash page using the marginal read mode (marginal 0). If PSA sum differs from expected PSA value the affected flash page has to be reprogrammed.
or
- Start flash erasing from RAM and limit system frequency to <1MHz (to ensure 6-us delay after EEIEX). If the last instruction before erasing is located in RAM, flash cell degradation does not occur.

JTAG23

JTAG Module

Category

Debug

Function

PSA checksum calculation does not work in marginal read mode.

Description

If the PSA checksum is calculated via JTAG interface in marginal read mode the MRG0 and MRG1 bits in the FCTL4 register are reset.

Workaround

None.

PORT10

PORT Module

Category

Functional

Function

Pull-up/down resistor selection when module pin function is selected

Description

When the pull-up/down resistor for a certain port pin is enabled (PxREN.y=1) and the module port pin function is selected (PxSEL.y=1), the pull-up/down resistor configuration of this pin is controlled by the respective module output signal (Module X OUT) instead of the port output register (PxOUT.y).

Workaround None. Do not set PxSEL.y and PxREN.y at the same time.

PORT12 ***PORT Module***

Category Functional

Function PxIFG is set on PUC

Description The PxIN register is cleared when a PUC is asserted, and it regains the original value after the PUC is de-asserted. If the PxIN register bits read high, asserting a PUC causes clearing of the register, which results in a high-to-low transition. Once the PUC is de-asserted, the PxIN register is restored to high, which results in a low-to-high transition. This behavior results in the PxIFG being set regardless of the PxIES setting.

Workaround Prior to setting PxIE bits ensure that corresponding PxIFG bits are cleared.

TA12 ***TA Module***

Category Functional

Function Interrupt is lost (slow ACLK)

Description Timer_A counter is running with slow clock (external TACLK or ACLK) compared to MCLK. The compare mode is selected for the capture/compare channel and the CCRx register is incremented by one with the occurring compare interrupt (if TAR = CCRx). Due to the fast MCLK the CCRx register increment (CCRx = CCRx+1) happens before the Timer_A counter has incremented again. Therefore the next compare interrupt should happen at once with the next Timer_A counter increment (if TAR = CCRx + 1). This interrupt gets lost.

Workaround Switch capture/compare mode to capture mode before the CCRx register increment. Switch back to compare mode afterwards.

TA16 ***TA Module***

Category Functional

Function First increment of TAR erroneous when IDx > 00

Description The first increment of TAR after any timer clear event (POR/TACLR) happens immediately following the first positive edge of the selected clock source (INCLK, SMCLK, ACLK or TACLK). This is independent of the clock input divider settings (ID0, ID1). All following TAR increments are performed correctly with the selected IDx settings.

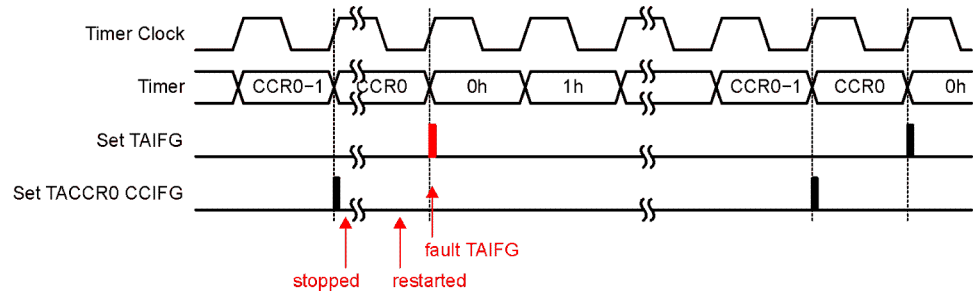
Workaround None

TA21 ***TA Module***

Category Functional

Function TAIFG Flag is erroneously set after Timer A restarts in Up Mode

Description In Up Mode, the TAIFG flag should only be set when the timer counts from TACCR0 to zero. However, if the Timer A is stopped at TAR = TACCR0, then cleared (TAR=0) by setting the TACLR bit, and finally restarted in Up Mode, the next rising edge of the TACLK will erroneously set the TAIFG flag.



Workaround None.

TAB22 *TAB Module*

Category Functional

Function Timer_A/Timer_B register modification after Watchdog Timer PUC

Description Unwanted modification of the Timer_A/Timer_B registers TACTL/TBCTL and TAIV/TBIV can occur when a PUC is generated by the Watchdog Timer(WDT) in Watchdog mode and any Timer_A/Timer_B counter register TACCRx/TBCCRx is incremented/decremented (Timer_A/Timer_B does not need to be running).

Workaround Initialize TACTL/TBCTL register after the reset occurs using a MOV instruction (BIS/BIC may not fully initialize the register). TAIV/TBIV is automatically cleared following this initialization.

Example code:

```
MOV.W #VAL, &TACTL
or
MOV.W #VAL, &TBCTL
```

Where, VAL=0, if Timer is not used in application otherwise, user defined per desired function.

TB2 *TB Module*

Category Functional

Function Interrupt is lost (slow ACLK)

Description Timer_B counter is running with slow clock (external TBCLK or ACLK) compared to MCLK. The compare mode is selected for the capture/compare channel and the CCRx register is incremented by 1 with the occurring compare interrupt (if TBR = CCRx). Due to the fast MCLK, the CCRx register increment (CCRx = CCRx + 1) happens before the Timer_B counter has incremented again. Therefore, the next compare interrupt should happen at once with the next Timer_B counter increment (if TBR = CCRx + 1). This interrupt is lost.

Workaround Switch capture/compare mode to capture mode before the CCRx register increment. Switch back to compare mode afterward.

TB16 *TB Module*

Category Functional

Function First increment of TBR erroneous when IDx > 00

Description The first increment of TBR after any timer clear event (POR/TBCLR) happens immediately following the first positive edge of the selected clock source (INCLK, SMCLK, ACLK, or TBCLK). This is independent of the clock input divider settings (ID0, ID1). All following TBR increments are performed correctly with the selected IDx settings.

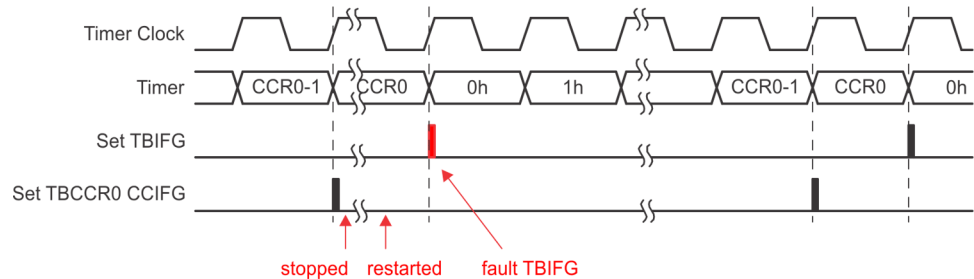
Workaround None

TB24 ***TB Module***

Category Functional

Function TBIFG Flag is erroneously set after Timer B restarts in Up Mode

Description In Up Mode, the TBIFG flag should only be set when the timer resets from TBCCR0 to zero. However, if the Timer B is stopped at TBR = TBCCR0, then cleared (TBR=0) by setting the TBCLR bit, and finally restarted in Up Mode, the next rising edge of the TBCLK will erroneously set the TBIFG flag.



Workaround None.

USCI20 ***USCI Module***

Category Functional

Function I2C Mode Multi-master transmitter issue

Description When configured for I2C master-transmitter mode, and used in a multi-master environment, the USCI module can cause unpredictable bus behavior if all of the following four conditions are true:

- 1 - Two masters are generating SCL
- And
- 2 - The slave is stretching the SCL low phase of an ACK period while outputting NACK on SDA
- And
- 3 - The slave drives ACK on SDA after the USCI has already released SCL, and then the SCL bus line gets released
- And
- 4 - The transmit buffer has not been loaded before the other master continues communication by driving SCL low

The USCI will remain in the SCL high phase until the transmit buffer is written. After the transmit buffer has been written, the USCI will interfere with the current bus activity and may cause unpredictable bus behavior.

- Workaround**
- 1 - Ensure that slave doesn't stretch the SCL low phase of an ACK period
 - Or
 - 2 - Ensure that the transmit buffer is loaded in time
 - Or
 - 3 - Do not use the multi-master transmitter mode

USCI21 *USCI Module*

Category Functional

Function UART IrDA receive filter

Description The IrDA receive filter can be used to filter pulses with length UCAIRRXFL configured in UCAXIRRCTL register. If UCIRRXFE is set the IrDA receive decoder may filter out pulses longer than the configured filter length depending on frequency of BRCLK. This is resulting in framing errors or corrupted data on the receiver side.

Workaround Depending on the used baud rate and the configured filter length a maximum frequency for BRCLK needs to be set to avoid this issue:

For baud rates equal and higher than 115.000 the maximum allowed BRCLK frequency is equal to the max specified system frequency.

$$\text{Max BRCLK} = \frac{\text{Filter Length} + 64}{2} \times \frac{\text{Baud Rate} \times 16}{3 \times 10^6}$$

| Baud Rate | Filter Length UCIRRXFL (dec) | Max BRCLK (MHz) |
|-----------|---------------------------------|-----------------|
| 9600 | 64 | 3.28 |
| | 32 | 2.46 |
| | 16 | 2.05 |
| | 8 | 1.84 |
| | 4 | 1.74 |
| | 2 | 1.69 |
| | 1 | 1.66 |
| | 0 | 1.64 |
| 19200 | 64 | 6.55 |
| | 32 | 4.92 |
| | 16 | 4.1 |
| | 8 | 3.69 |
| | 4 | 3.48 |
| | 2 | 3.38 |
| | 1 | 3.33 |
| | 0 | 3.28 |
| 38400 | 64 | 13.11 |
| | 32 | 9.83 |
| | 16 | 8.19 |
| | 8 | 7.37 |
| | 4 | 6.96 |
| | 2 | 6.76 |
| | 1 | 6.66 |
| | 0 | 6.55 |
| 56000 | 64 | 19.11 |
| | 32 | 14.34 |
| | 16 | 11.95 |
| | 8 | 10.75 |
| | 4 | 10.15 |
| | 2 | 9.86 |
| | 1 | 9.71 |
| | 0 | 9.56 |

USCI22 *USCI Module*

Category Functional

Function I2C Master Receiver with 10-bit slave addressing

Description Unexpected behavior of the USCI_B can occur when configured in I2C master receive mode with 10-bit slave addressing under the following conditions:

- 1) The USCI sends first byte of slave address, the slave sends an ACK and when second address byte is sent, the slave sends a NACK.
- 2) Master sends a repeat start condition (If UCTXSTT=1).
- 3) The first address byte following the repeated start is acknowledged.

However, the second address byte is not sent, instead the Master incorrectly starts to receive data and sets UCBxRXIFG=1.

Workaround Do not use repeated start condition instead set the stop condition UCTXSTP=1 in the NACK ISR prior to the following start condition (USTXSTT=1).

USCI23 *USCI Module*

Category Functional

Function UART transmit mode with automatic baud rate detection

| | |
|--------------------|--|
| Description | Erroneous behavior of the USCI_A can occur when configured in UART transmit mode with automatic baud rate detection. During transmission if a "Transmit break" is initiated (UCTXBRK=1), the USCI_A will not deliver a stop bit of logic high, instead, it will send a logic low during the subsequent synch period. |
| Workaround | 1) Follow User's Guide instructions for transmitting a break/synch field following UCSWRST=1. Or, 2) Set UCTXBRK=1 before an active transmission, i.e. check for bit UCBUSY=0 and then set UCTXBRK=1. |

USCI24 *USCI Module*

| | |
|--------------------|--|
| Category | Functional |
| Function | Incorrect baud rate information during UART automatic baud rate detection mode |
| Description | Erroneous behavior of the USCI_A can occur when configured in UART mode with automatic baud rate detection. After automatic baud rate measurement is complete, the UART updates UCAXBR0 and UCAXBR1. Under Oversampling mode (UCOS16=1), for baud rates that should result in UCAXBRx=0x0002, the UART incorrectly reports it as UCAXBRx=0x5555. |
| Workaround | When break/synch is detected following the automatic baud rate detection, the flag UCBRK flag is set to 1. Check if UCAXBRx=0x5555 and correct it to 0x0002. |

USCI25 *USCI Module*

| | |
|--------------------|--|
| Category | Functional |
| Function | TXIFG is not reset when NACK is received in I2C mode |
| Description | When the USCI_B module is configured as an I2C master transmitter the TXIFG is not reset after a NACK is received if the master is configured to send a restart (UCTXSTT=1 & UCTXSTP=0). |
| Workaround | Reset TXIFG in software within the NACKIFG interrupt service routine |

USCI26 *USCI Module*

| | |
|--------------------|---|
| Category | Functional |
| Function | Tbuf parameter violation in I2C multi-master mode |
| Description | In multi-master I2C systems the timing parameter Tbuf (bus free time between a stop condition and the following start) is not guaranteed to match the I2C specification of 4.7us in standard mode and 1.3us in fast mode. If the UCTXSTT bit is set during a running I2C transaction, the USCI module waits and issues the start condition on bus release causing the violation to occur. Note: It is recommended to check if UCBBUSY bit is cleared before setting UCTXSTT=1. |
| Workaround | None |

USCI27 *USCI Module*

| | |
|-----------------|------------|
| Category | Functional |
|-----------------|------------|

| | |
|--------------------|---|
| Function | Timing of USCI I2C interrupts may cause device reset due to automatic clear of an IFG. |
| Description | <p>When certain USCI I2C interrupt flags (IFG) are set and an automatic flag-clearing event on the I2C bus occurs, the program counter may become corrupted. This will only happen when the IFG is cleared within a critical time window (~6 CPU clock cycles) after a USCI interrupt request occurs and before the interrupt servicing is initiated. The affected interrupts are UCBxTXIFG, UCSTPIFG, UCSTTIFG and UCNACKIFG.</p> <p>The automatic flag-clearing scenarios are described in the following situations:</p> <p>(1) A pending UCBxTXIFG interrupt request is cleared on the falling SCL clock edge following a NACK.</p> <p>(2) A pending UCSTPIFG, UCSTTIFG, or UCNACKIFG interrupt request is cleared by a following Start condition.</p> |
| Workaround | <p>(1) Polling the affected flags instead of enabling the interrupts.</p> <p>or</p> <p>(2) Ensuring the above mentioned flag-clearing events occur after a time delay of 6 CPU clock cycles has elapsed since the interrupt request occurred and was accepted.</p> |

| | |
|--------------------|--|
| USCI30 | <i>USCI Module</i> |
| Category | Functional |
| Function | I2C mode master receiver / slave receiver |
| Description | <p>When the USCI I2C module is configured as a receiver (master or slave), it performs a double-buffered receive operation. In a transaction of two bytes, once the first byte is moved from the receive shift register to the receive buffer the byte is acknowledged and the state machine allows the reception of the next byte.</p> <p>If the receive buffer has not been cleared of its contents by reading the UCBxRXBUF register while the 7th bit of the following data byte is being received, an error condition may occur on the I2C bus. Depending on the USCI configuration the following may occur:</p> <p>1) If the USCI is configured as an I2C master receiver, an unintentional repeated start condition can be triggered or the master switches into an idle state (I2C communication aborted). The reception of the current data byte is not successful in this case.</p> <p>2) If the USCI is configured as I2C slave receiver, the slave can switch to an idle state stalling I2C communication. The reception of the current data byte is not successful in this case. The USCI I2C state machine will notify the master of the aborted reception with a NACK.</p> <p>Note that the error condition described above occurs only within a limited window of the 7th bit of the current byte being received. If the receive buffer is read outside of this window (before or after), then the error condition will not occur.</p> |
| Workaround | <p>a) The error condition can be avoided altogether by servicing the UCBxRXIFG in a timely manner. This can be done by (a) servicing the interrupt and ensuring UCBxRXBUF is read promptly or (b) Using the DMA to automatically read bytes from receive buffer upon UCBxRXIFG being set.</p> <p>OR</p> <p>b) In case the receive buffer cannot be read out in time, test the I2C clock line before the UCBxRXBUF is read out to ensure that the critical window has elapsed. This is done by checking if the clock line low status indicator bit UCSCLLOW is set for atleast three USCI bit clock cycles i.e. $3 \times t(\text{BitClock})$.</p> |

Note that the last byte of the transaction must be read directly from UCBxRXBUF. For all other bytes follow the workaround:

Code flow for workaround

- (1) Enter RX ISR for reading receiving bytes
- (2) Check if UCSCLLow.UCBxSTAT == 1
- (3) If no, repeat step 2 until set
- (4) If yes, repeat step 2 for a time period $> 3 \times t(\text{BitClock})$ where $t(\text{BitClock}) = 1/f(\text{BitClock})$
- (5) If window of $3 \times t(\text{BitClock})$ cycles has elapsed, it is safe to read UCBxRXBUF

USCI34

USCI Module

Category

Functional

Function

I2C multi-master transmit may lose first few bytes.

Description

In an I2C multi-master system (UCMM =1), under the following conditions:

- (1)the master is configured as a transmitter (UCTR =1)

AND

- (2)the start bit is set (UCTXSTT =1);

if the I2C bus is unavailable, then the USCI module enters an idle state where it waits and checks for bus release. While in the idle state it is possible that the USCI master updates its TXIFG based on clock line activity due to other master/slave communication on the bus. The data byte(s) loaded in TXBUF while in idle state are lost and transmit pointers initialized by the user in the transmit ISR are updated incorrectly.

Workaround

Verify that the START condition has been sent (UCTXSTT =0) before loading TXBUF with data.

Example:

```
#pragma vector = USCIAB0TX_VECTOR
__interrupt void USCIAB0TX_ISR(void)
{
// Workaround for USCI34
if(UCB0CTL1&UCTXSTT)
{
// TXData = pointer to the transmit buffer start
// PTxData = pointer to transmit in the ISR
PTxData = TXData; // restore the transmit buffer pointer if the Start bit is set
}
//
if(IFG2&UCB0TXIFG)
{
if (PTxData <= PTxDataEnd) // Check TX byte counter
{
UCB0TXBUF = *PTxData++; // Load TX buffer
}
else
{
UCB0CTL1 |= UCTXSTP; // I2C stop condition
```

```
IFG2 &= ~UCB0TXIFG; // Clear USCI_B0 TX int flag
__bic_SR_register_on_exit(CPUOFF); // Exit LPM0
}
}
}
```

USCI35

USCI Module

Category

Functional

Function

Violation of setup and hold times for (repeated) start in I2C master mode

Description

In I2C master mode, the setup and hold times for a (repeated) START, $t_{SU,STA}$ and $t_{HD,STA}$ respectively, can be violated if SCL clock frequency is greater than 50kHz in standard mode (100kbps). As a result, a slave can receive incorrect data or the I2C bus can be stalled due to clock stretching by the slave.

Workaround

If using repeated start, ensure SCL clock frequencies is < 50kHz in I2C standard mode (100 kbps).

USCI40

USCI Module

Category

Functional

Function

SPI Slave Transmit with clock phase select = 1

Description

In SPI slave mode with clock phase select set to 1 (UCAxCTLW0.UCCKPH=1), after the first TX byte, all following bytes are shifted by one bit with shift direction dependent on UCMSB. This is due to the internal shift register getting pre-loaded asynchronously when writing to the USCIA TXBUF register. TX data in the internal buffer is shifted by one bit after the RX data is received.

Workaround

Reinitialize TXBUF before using SPI and after each transmission.
If transmit data needs to be repeated with the next transmission, then write back previously read value:

```
UCAxTXBUF = UCAxTXBUF;
```

XOSC5

XOSC Module

Category

Functional

Function

LF crystal failures may not be properly detected by the oscillator fault circuitry

Description

The oscillator fault error detection of the LFXT1 oscillator in low frequency mode (XTS = 0) may not work reliably causing a failing crystal to go undetected by the CPU, i.e. OFIFG will not be set.

Workaround

None

XOSC8

XOSC Module

Category

Functional

Function

ACLK failure when crystal ESR is below 40 kOhm.

| | |
|--------------------|--|
| Description | When ACLK is sourced by a low frequency crystal with an ESR below 40 kOhm, the duty cycle of ACLK may fall below the specification; the OFIFG may become set or in some instances, ACLK may stop completely. |
| Workaround | Please refer to "XOSC8 Guidance" found at SLAA423 for information regarding working with this erratum. |

7 Revision History

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

| Changes from April 21, 2020 to May 19, 2021 | Page |
|--|-------------|
| <ul style="list-style-type: none">Changed the document format and structure; updated the numbering format for tables, figures, and cross references throughout the document..... | 6 |

IMPORTANT NOTICE AND DISCLAIMER

TI PROVIDES TECHNICAL AND RELIABILITY DATA (INCLUDING DATA SHEETS), DESIGN RESOURCES (INCLUDING REFERENCE DESIGNS), APPLICATION OR OTHER DESIGN ADVICE, WEB TOOLS, SAFETY INFORMATION, AND OTHER RESOURCES "AS IS" AND WITH ALL FAULTS, AND DISCLAIMS ALL WARRANTIES, EXPRESS AND IMPLIED, INCLUDING WITHOUT LIMITATION ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS.

These resources are intended for skilled developers designing with TI products. You are solely responsible for (1) selecting the appropriate TI products for your application, (2) designing, validating and testing your application, and (3) ensuring your application meets applicable standards, and any other safety, security, regulatory or other requirements.

These resources are subject to change without notice. TI grants you permission to use these resources only for development of an application that uses the TI products described in the resource. Other reproduction and display of these resources is prohibited. No license is granted to any other TI intellectual property right or to any third party intellectual property right. TI disclaims responsibility for, and you will fully indemnify TI and its representatives against, any claims, damages, costs, losses, and liabilities arising out of your use of these resources.

TI's products are provided subject to [TI's Terms of Sale](#) or other applicable terms available either on ti.com or provided in conjunction with such TI products. TI's provision of these resources does not expand or otherwise alter TI's applicable warranties or warranty disclaimers for TI products.

TI objects to and rejects any additional or different terms you may have proposed.

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265
Copyright © 2022, Texas Instruments Incorporated